PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
SanDisk Corporation	04/04/2011

RECEIVING PARTY DATA

Name:	SanDisk Technologies Inc.
Street Address:	6900 North Dallas Parkway
Internal Address:	Two Legacy Town Center
City:	Plano
State/Country:	TEXAS
Postal Code:	75024

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	11770078

CORRESPONDENCE DATA

Fax Number: (408)801-9019

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

Phone: 4088012863

Email: simona.benjamin@sandisk.com

Correspondent Name: SanDisk Corporation

Address Line 1: 601 Mccarthy Boulevard

Address Line 2: Patent Department/Simona Benjamin

Address Line 4: Milpitas, CALIFORNIA 95035

ATTORNEY DOCKET NUMBER: SDA-1169X-US

NAME OF SUBMITTER: Simona Benjamin

Total Attachments: 5

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> PATENT REEL: 026261 FRAME: 0881

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ASSIGNMENT

WHEREAS, SanDisk Corporation, a Delaware corporation, doing business at 601 McCarthy Boulevard, Milpitas, CA 95035 (hereinafter referred to as ASSIGNOR), holds right, title and interest throughout the world in and to the patents and patent applications set forth in the attached Exhibit A, together with all divisions, continuations, or continuations-in-part thereof, and all patents issuing thereon including reissues, renewals, substitutions, re-examinations and extensions thereof, and any and all corresponding foreign patents and patent applications (hereinafter referred to as, collectively, THE ASSIGNED PATENT RIGHTS);

WHEREAS, SanDisk Technologies Inc., a Texas corporation, doing business at Two Legacy Town Center, 6900 North Dallas Parkway, Plano, Texas 75024, (hereinafter referred to as ASSIGNEE), is desirous of acquiring the full and exclusive right, title and interest in THE ASSIGNED PATENT RIGHTS;

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, ASSIGNOR hereby assigns, transfers and conveys unto the said ASSIGNEE, and ASSIGNEE accepts, all of ASSIGNOR's right, title and interest throughout the world in and to THE ASSIGNED PATENT RIGHTS and to all Letters Patent or applications or similar legal protection, not only in the United States and its territorial possessions, but in all countries foreign thereto to be obtained for THE ASSIGNED PATENT RIGHTS, and to any continuation, division, renewal, substitute or reissue thereof or any legal equivalent thereof in the United States or a foreign country for the full term or terms for which the same may be granted, including all priority rights under the International Convention; and ASSIGNOR hereby authorizes and requests the United States Commissioner of Patents and Trademarks and any officials of foreign countries whose duty it is to issue patents on applications as aforesaid, to issue all patents for THE ASSIGNED PATENT RIGHTS to ASSIGNEE in accordance with the terms of this ASSIGNMENT but subject to reserved rights including but not limited to those previously retained by, granted to, or owned by, the United States government, educational institutions or both and hereby transfers and conveys all rights of action, power and benefit belonging to or accruing from THE ASSIGNED PATENT RIGHTS including the right to undertake proceedings to recover past and future damages and claim all other relief in respect of any acts of infringement thereof whether such acts shall have been committed before or after the date of this assignment.

No other rights, immunities, or licenses, including, without limitation, any rights to any intellectual property owned, controlled or licensable by **Assignor** are granted or assigned to ASSIGNEE under this ASSIGNMENT, either expressly or by implication, estoppel, or otherwise, other than the rights expressly recited herein.

ASSIGNOR hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would knowingly conflict with this Agreement;

ASSIGNOR further covenants that ASSIGNEE will, upon its lawful request, reasonably be provided with all pertinent facts and documents relating to THE ASSIGNED PATENT RIGHTS and legal equivalents as may be known and reasonably accessible to ASSIGNOR and that ASSIGNOR will testify as to the same in any administrative contest or litigation related thereto and will promptly execute and deliver to ASSIGNEE or its legal representative any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce THE ASSIGNED PATENT RIGHTS and said equivalents in the United States or in any foreign country, which may be necessary or desirable to carry out the purposes thereof.

IN TESTIMONY WHEREOF, I hereunto set my hand as of the date indicated below.

SANDISK CORPORATION

Dated: 4th April 2011	Andy Bruner Name: Judy Bruner Title: EVP and CFO					
STATE OF California)ss.						
	ore me Area I Branson Watan (notary public) the undersigned Notary					
within instrument and acknowledged to me that	nce to be the person(s) whose name(s) is/are subscribed to the he/she/they executed the same in his/her/their authorized the instrument the person(s), or the entity upon behalf of which					
I certify under PENALTY OF PERJURY under the lar and correct.	ws of the State of California that the foregoing paragraph is true					
	WITNESS my hand and official seal.					
AVERIL BRANWEN WATAN Commission # 1742706 Notary Public - California Santa Clara County My Comm. Expires Apr 29, 2011	Signature: Signature of Notary Public					
	We accept the Assignment					
SANDISK TECHNOLOGIES INC.						
Dated: 4/4/11	Name: James F. Brelsford Title: President and Sceretary					
STATE OF California)	· ·					
STATE OF California COUNTY OF Santo Clora)ss.						
On this 4 day of April, 2011, before Public, personally appeared 1 fames f. Be	ore me the undersigned Notary					
who proved to me on the basis of satisfactory evider	nce to be the person(s) whose name(s) is/are subscribed to the he/she/they executed the same in his/her/their authorized					

capacity(ies), and that by his/her/their signature(s) on the instrument the person(s), or the entity upon behalf of which the person(s) acted, executed the instrument.

I certify under PENALTY OF PERJURY under the laws of the State of California that the foregoing paragraph is true and correct.

Signature: <u>Signature of Notary Public</u> L. BENJAMIN Commission # 1893105 Notary Public - California Santa Clara County

WITNESS my hand and official seal.

Exhibit A

FILE#	INVENTORS	TITLE	COUNTRY	STATUS	SER#	FILING DATE	PAT#	ISSUE DATE
SDA-1167X-US	Shih-Chung Lee	Coarse/Fine Program Verification in Non-Volatile	US	Issued	11773032	3-Jul-07	7508715	24-Mar-09
		Memory Using Different Reference Levels for						
		Improving Sensing						
SDA-1167Y-US	Shih-Chung Lee	Systems for Coarse/Fine Program Verification in	US	Issued	11773035	3-Jul-07	7599224	6-Oct-09
		Non-Volatile Memory Using Different Reference						
		Levels for Improving Sensing						
SDA-1168X-I-US	Cheeman Yu, Vani Verma, Hem Takiar	Method of Fabricating a Two-Sided Die in a Four-	US	Published	12819818	21-Jun-10		
		Sided Leadframe Based Package						
SDA-1168X-US	Cheeman Yu, Vani Verma, Hem Takiar	Method of Fabricating a Two-Sided Die in a Four-	US	Allowed	11770052	28-Jun-07		
		Sided Leadframe Based Package						
SDA-1168Y-US	Cheeman Yu, Vani Verma, Hem Takiar	Two-Sided Die in a Four-Sided Leadframe Based	US	Published	11770066	28-Jun-07		
		Package						
SDA-1169X-US	Chin-Tien Hope Chiu, Hem Takiar, Chih	Method of Fabricating a Semiconductor Package	US	Allowed	11770078	28-Jun-07		
	Chin Liao, Cheeman Yu, Ning Ye, Jack	having Through Holes for Molding Back Side of						
	Chang Chien	Package						
SDA-1169Y-US	Chin-Tien Hope Chiu, Hem Takiar, Chih	Semiconductor Package having Through Holes for	US	Published	11770088	28-Jun-07		
	Chin Liao, Cheeman Yu, Ning Ye, Jack	Molding Back Side of Package						
	Chang Chien							
SDA-1170X-US	Andrew (Chien-Ko) Liao, Chin-Tien Hope		US	Issued	11769927	28-Jun-07	7772047	10-Aug-10
	Chiu, Jack Chang Chien, Cheeman Yu, Hem	a Redistribution Layer						
	Takiar							
SDA-1170Y-I-US	Andrew (Chien-Ko) Liao, Chin-Tien Hope	Semiconductor Die Having a Redistribution Layer	US	Allowed	12843279	26-Jul-10		
	Chiu, Jack Chang Chien, Cheeman Yu, Hem							
**************************************	Takiar				4450005			071140
SDA-1170Y-US	Andrew (Chien-Ko) Liao, Chin-Tien Hope	Semiconductor Die Having a Redistribution Layer	US	Issued	11769937	28-Jun-07	7763980	27-Jul-10
	Chiu, Jack Chang Chien, Cheeman Yu, Hem							
CD 4 4474V LIC	Takiar	Markada Effeksississa - Massassa Condition	ur	Darle Park and	11700043	20 1 07		
SDA-1171X-US	Ning Ye, Robert C Miller, Cheeman Yu,	Method of Fabricating a Memory Card Using	US	Published	11769942	28-Jun-07		
CDA 1171V HC	Hem Takiar, Andre McKenzie Ning Ye, Robert C Miller, Cheeman Yu,	SIP/SMT Hybrid Technology	US	leeu o d	11700054	20 Jun 07	7772606	10 Aug 10
SDA-1171Y-US	, , , , , , , , , , , , , , , , , , , ,	Memory Card Fabricated Using SIP/SMT Hybrid	05	Issued	11769954	28-Jun-07	7772686	10-Aug-10
SDA-1174X-US	Hem Takiar, Andre McKenzie Jonathan Hubert, Jason Patrick Hanlon,	Technology Method of Adapting an Expresscard Slot for Smaller	HC	Published	11771763	29-Jun-07		
3DA-11/4X-03		' ' '	03	rublisheu	11//1/03	23-Jun-07		
SDA-1174Y-US	Jordan MacDonald Jonathan Hubert, Jason Patrick Hanlon,	Form Factor Memory Compatibility Adaptor for an Expresscard Slot	US	Issued	11771767	29-Jun-07	7699660	20-Apr-10
DA-11/41-03	· ·	Adaptor for all expressed disloc	03	issueu	117/1/07	Z3-Juli-0/	7033000	20-Apr-10
SDA-1175Y-I-US	Jordan MacDonald Jonathan Hubert, Jason Patrick Hanlon,	Memory Card for an Expresscard Slot	US	Published	12727519	19-Mar-10		
204-11/21-1-02	Jordan MacDonald, Wesley G. Brewer	Inventory Card for an Expression Stot	03	rublisticu	12/2/313	13-14191-10		
	Jordan MacDonald, Wesley G. Brewer							
SDA-1175Y-US	Jonathan Hubert, Jason Patrick Hanlon,	Memory Card for an Expresscard Slot	US	Issued	11771756	29-Jun-07	7686654	30-Mar-10
2011 11131 03	Jordan MacDonald, Wesley G. Brewer	internally during for all Expression of State		ijjacu	11771130	23 3411 07	7000037	DO MINI TO
	portain MacDonald, Wesley G. Drewel							
SDA-1176Y-US	Jonathan Hubert, Jason Patrick Hanlon,	Adapter System for Use with ExpressCard Slot	US	Issued	11771730	29-Jun-07	7780477	24-Aug-10
1704-111/01-02	Matthiis Hutten	The property of the state of th	-		12,,17,00		1100111	1-1.05 10
SDA-1177X-US	Jonathan Hubert, Jason Patrick Hanlon	Method of Using the Dual Bus Interface in an	US	Issued	11771744	29-Jun-07	7779184	17-Aug-10
		ExpressCard Slot	-	.====				
SDA-1177Y-US	Jonathan Hubert, Jason Patrick Hanlon	Dual Bus ExpressCard Peripheral Device	US	Published	11771752	29-Jun-07		
SDA-11771-03	Gerrit Jan Hemink, Teruhiko Kamei	Erase Voltage Manipulation in Non-Volatile Memory		Issued	11773921	5-Jul-07	7457166	25-Nov-08
	Gerricaan nemink, retuniko kainei	· · · · · · · · · · · · · · · · · · ·	03	Issueu	11//35/1	לטרוטניכן	143/100	ZJ-1808*00
		for Controlled Shifts in Threshold Voltage						

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